	Material Composit © Copyright 2005. IPC, I international and Pan-Am	Bannockb	urn, Illinois. A	ll rights reserved untions.	under both	This docum level parts,	ent is a decla the declaration	tration of on encon	of the substances npasses all lowe	s within the manufactor er level materials for v	urer listed which the 1	item. Note: if nanufacturer	the item is an a has engineering	ssembly with lower responsibility.	
					Form Type Distribute	Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homogeneous Ma				, Homogeneous Mate	erials and Mfg Information				
Supplier Informat	ion														
Company name*			Company unique ID			Unique ID Authority					Response Date*				
onsemi											2025-05	2025-05-13			
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative			Phone - Representative*				Email -	Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com				
Requester It	Requester Item Number Mfr Item		Number Mfr Item Name				Effective D	Date Version Manufacturing Site			Weight*	UOM	Unit Type		
		FDMC8010DC		FET 30V 1.3 mOhm PQFN33			2025-05-13	;		РВВ		70.635765	mg	Each	
Manufacturing Pr	occess Information	L					•								
Terminal Plating / Grid Array Material Termi			erminal Base A	Base Alloy J-STD-020 MSL Rat		L Rating	Peak Process Body Temperature Ma		are Max Time at Pea	ak Temperature Number of Reflow Cycles		cles			
Matte Tin (Sn) - annealed CU Alloy			U Alloy		1		260		С	30	seco	nds 3			
Comments															
level 1 - maximum time	e at peak temperature d	uring sol	dering is 10-3	0 seconds											
For more information i	regarding material com	position p	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in ifies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temp	erature type solders (i.e. lead based sol	der alloys containing 85% by weight or m	ore lead).								
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	8.097	mg	Supplier	Zinc (Zn)	7440-66-6		0.011	mg
			Supplier	Iron (Fe)	7439-89-6		0.194	mg
			Supplier	Copper (Cu)	7440-50-8		7.892	mg
Die	0.99	mg	Supplier	Silicon (Si)	7440-21-3		0.99	mg
Die Attach Solder	1.989	mg	Supplier	Silver (Ag)	7440-22-4		0.0497	mg
			А	Lead (Pb)	7439-92-1	7a	1.8398	mg
			Supplier	Tin (Sn)	7440-31-5		0.0994	mg
Lead Frame	20.211	mg	Supplier	Zinc (Zn)	7440-66-6		0.026	mg
			Supplier	Iron (Fe)	7439-89-6		0.485	mg
			Supplier	Copper (Cu)	7440-50-8		19.7	mg
Mold Compound-Black	14.236	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.712	mg
			Supplier	Carbon Black (C)	1333-86-4		0.142	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		12.67	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.712	mg
Plating	25.1	mg	Supplier	Tin (Sn)	7440-31-5		25.1	mg
Wire Bond	0.012765	mg	Supplier	Palladium (Pd)	7440-05-3		0.0003	mg
			Supplier	Gold (Au)	7440-57-5		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0124	mg